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LED Specification

EC/Opto Group

PC851XNxiP0F Series Photocoupler

Product Specification November 2009

PC851XNxiP0F Series
Full Specification for part numbers:
PC851XNNiP0F
PC851XNYiP0F





SHARP

SYSTEM DEVICE DIVISION [ELECTRONIC COMPONENTS AND DEVICES GROUP SHARP CORPORATION

SPECIFICATION

DEVICE SPECIFICATION FOR	
PHOTOCOUPLER MODEL No.	
PC851	
Business dealing name	
PC851XNNIP0F PC851	XNYIP0F
Specified for	
Enclosed please find copies of the Specifications which consists of This specification sheets and attached sheets shall be both side confirmation of the contents, please be sure to send back with approving signature on each.	py.
CUSTOMER'S APPROVAL	PRESENTED
DATE	DATE NOV. 10, 2009
ВҮ	BY Hon M. Kubo, Department General Manager of Development Dept. IV System Device Div. I Electronic Components and Devices Group SHARP CORPORATION

REFORMING CE

Product name: PHOTOCOUPLER

Model No.: PC851

Business dealing name

PC851XNNIP0F | PC851XNYIP0F

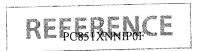
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- When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

- (1) Please do verify the validity of this part after assembling it in customer's products, when customer wants to make catalogue and instruction manual based on the specification sheet of this part.
- (2) This product is designed for use in the following application areas;
 - · OA equipment Audio visual equipment · Home appliances
 - · Telecommunication equipment (Terminal) · Measuring equipment
 - · Tooling machines · Computers

If the use of the product in the above application areas is for equipment listed in paragraphs (3) or (4), please be sure to observe the precautions given in those respective paragraphs.

- (3) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as;
 - · Transportation control and safety equipment (aircraft, train, automobile etc.)
 - · Traffic signals · Gas leakage sensor breakers · Rescue and security equipment
 - · Other safety equipment
- (4) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as;
 - · Space equipment · Telecommunication equipment (for trunk lines)
 - · Nuclear power control equipment · Medical equipment
- (5) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above four paragraphs.
- 3. Please contact and consult with a Sharp sales representative for any questions about this product.



1. Application

This specification applies to the outline and characteristics of photocoupler Model No. PC851 (Lead-Free Type).

2. Outline Refer to the attached sheet, page 4.

3. Ratings and characteristics Refer to the attached sheet, page 5, 6.

Reliability Refer to the attached sheet, page 7.

Outgoing inspection Refer to the attached sheet, page 8.

6. Supplement

6.1 Isolation voltage shall be measured in the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The dielectric withstanding tester with zero-cross circuit shall be used.
- (3) The wave form of applied voltage shall be a sine wave.

(It is recommended that the isolation voltage be measured in insulation oil.)

6.2 Package specifications Refer to the attached sheet, page 9, 10.

6.3 Business dealing name

("O" mark indicates business dealing name of ordered product)

Product	Business dealing name	Remark
	PC851XNNIP0F	
	PC851XNYIP0F	Applied to product as a option (Attachment-2-1 to 2-3.)

6.4 This Model is approved by UL.

Approved Model No.: PC851

UL file No.: E64380

6.5 This product is not designed against irradiation.

This product is assembled with electrical input and output.

This product incorporates non-coherent light emitting diode.

6.6 ODS materials

This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methyl chlorofonn)

6.7 Specified brominated flame retardants

Specified brominated flame retardants (PBB and PBDE) are not used in this device at all.



6.8 Compliance with each regulation

(1) The RoHS directive (2002/95/EC)

This product complies with the RoHS directive (2002/95/EC).

Object substances: mercury, lead, cadmium, hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE)

(2) Content of six substances specified in Management Methods for Control of Pollution Caused by Electronic Information Products Regulation (Chinese: 电子信息产品污染控制管理办法).

			Toxic	and hazardous su	ıbstances	
Category	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent chromium (Cr ⁶⁺)	Polybrominated biphenyls (PBB)	Polybrominated diphenyl ethers (PBDE)
Photocoupler	/	1	/	J	1	/

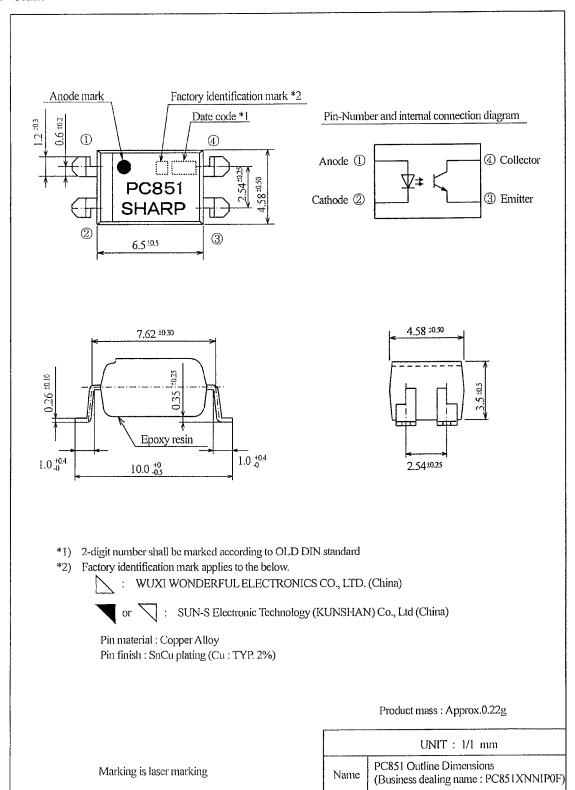
^{✓:} indicates that the content of the toxic and hazardous substance in all the homogeneous materials of the part is below the concentration limit requirement as described in SJ/T 11363-2006 standard.

7. Notes

Precautions for photocouplers : Attachment-1

REFERENCE

2. Outline



REFERENCE

3. Ratings and characteristics

3.1 Absolute maximum ratings Ta=25°C

		Parameter	Symbol	Rating	Unit
	*1	Forward current	I_{F}	50	mA
Input	*2	Peak forward current	I _{FM}	1	Α
Į.		Reverse voltage	V_R	6	V
	*1	Power dissipation	P	70	mW
		Collector-emitter voltage	V _{CEO}	350	V
Output		Emitter-collector voltage	V _{ECO}	6	V
g		Collector current	I _c	50	mА
	*1	Collector power dissipation	Pc	150	mW
	*1	Total power dissipation	P _{tot}	200	mW
		Operating temperature	Topr	-25 to +100	°C
		Storage temperature	T _{sty}	-55 to +125	℃
	*3	Isolation voltage	V _{iso(mns)}	5	kV
	*4	Soldering temperature	T _{sol}	270	ပ္

3.2 Electro-optical characteristics

Ta=25°C

Parameter S		Symbol	Condition	MIN.	TYP.	MAX.	Unit
Forward voltage		Forward voltage V _F I _F =20mA		-	1.2	1.4	V
Input	Reverse current	I_R	V _R =4V	1	•	10	μΑ
	Terminal capacitance	Ct	V=0, f=1kHz	-	30	250	pF
	Dark current	I _{CEO}	V _{CE} =200V, I _F =0	1	-	1	nA
Output	Collector-emitter breakdown voltage	BV _{CEO}	I _c =0.1mA, I _F =0	350	-	-	V
	Emitter-collector breakdown voltage	BV _{ECO}	I _E =10 μ A, I _F =0	6	-	-	V
	Collector current		I_F =51nA, V_{CE} =5 V	2.0	4.0	-	mA
	Collector-emitter saturation voltage	V _{CE(sat)}	I _F =20mA, I _c =1mA		0.1	0.3	V
Transfer	Isolation resistance	R _{ISO}	DC500V 40 to 60%RH	5×10 ¹⁰	1011	-	Ω
charac-	Floating capacitance	C_{f}	C _f V=0, f=1MHz		0.6	1.0	pF
teristics	Cut-off frequency	fc	V_{CE} =5V, I_c =2mA R_L =100 Ω , -3dB	-	50	-	kHz
	Rise time	tr	V _{CE} =2V, I _e =2mA	-	4	10	μS
	Fall time	tΓ	$R_L=100\Omega$	-	5	12	μs

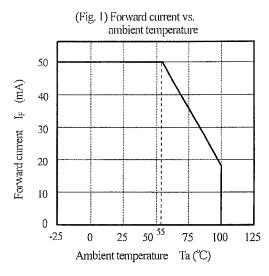
^{*1} The derating factors of absolute maximum ratings due to ambient temperature are shown in Fig. 1 to 4.

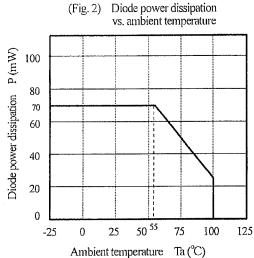
^{*2} Pulse width \leq 100 μ s, Duty ratio : 0.001 (Refer to Fig. 5)

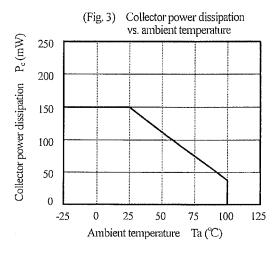
^{*3} AC for 1 min, 40 to 60%RH

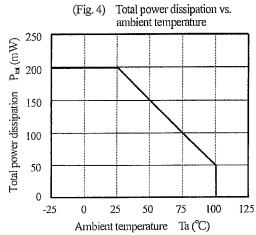
^{*4} For 10 s

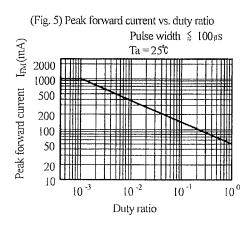
REPOSTENTION













4. Reliability

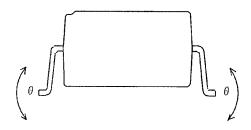
The reliability of products shall satisfy items listed below.

Confidence level: 90%

LTPD: 10or20

Test Items	Condition	Failure Judgment Criteria	Samples (n) Defective (C)
Solderability	245±3℃, 5s	*2	n=11, C=0
Soldering heat	(Flow soldering) 270°C, 10 s		n=11, C=0
Soldering heat	(Soldering by hand) 400°C, 3 s		11-11, 0-0
Terminal strength (Tension)	Weight: 5N 5 s/each tenninal	$V_F > U \times 1.2$ $I_R > U \times 2$	n=11, C=0
Terminal strength (Bending) *3	Weight: 2.5N 2 times/each terminal	I _{CEO} >U×2	n=11, C=0
Mechanical shock	15km/s^2 , 0.5ms 3 times/±X, ±Y, ±Z direction	I_{C} < L×0.7 $V_{CE(sol)}$ > U×1.2	n=11, C=0
Variable frequency vibration	100 to 2000 to 100Hz/4 min 200m/s ² 4 times/X, Y, Z direction		n=11, C=0
Temperature cycling	1 cycle −55 °C to +125 °C (30 min) (30 min) 20 cycles test	U: Upper specification limit	n=22, C=0
High temp. and high Humidity storage	+85°C, 85%RH, 1000h	L: Lower specification limit	n=22, C=0
High temp, storage	+125 ℃, 1000h		n=22, C=0
Low temp. storage	-55 °C, 1000h		n=22, C=0
Operation life	I _F =50mA, P _{tot} =200mW Ta=25 °C, 1000h		n=22, C=0

- *1 Test method, conforms to EIAJED 4701.
- *2 The product whose not-soldered area is more than 5% for all of the dipped area and/or whose pinholes or voids are concentrated on one place shall be judged defect.
- *3 Terminal bending direction is shown below.





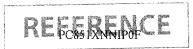
5. Outgoing inspection

- 5.1 Inspection items
- (1) Electrical characteristics $V_F,\,I_R,\,I_{CEO},\,V_{CE(sul)},\,I_c,\,R_{ISO},\,V_{iso}$
- (2) Appearance

5.2 Sampling method and Inspection level

A single sampling plan, normal inspection level II based on ISO 2859 is applied. The AQL according to the inspection items are shown below.

Defect	Inspection item	AQL(%)
Major defect	Electrical characteristics Unreadable marking	0.065
Minor defect	Appearance defect except the above mentioned.	0.25



6.2 Package specifications

6.2.1 Taping conditions

(1) Tape structure and Dimensions (Refer to the attached sheet, Page 9)

The carrier tape has the heat pressed structure of PS material carries tape and three layers cover tape (PET material base).

- (2) Reel structure and Dimensions (Refer to the attached sheet, Page 10) The taping reel shall be of plastic (PS material).
- (3) Direction of product insertion (Refer to the attached sheet, Page 10)
- (4) Joint of tape

The cover tape and carrier tape in one reel shall be joint less.

(5) To repair failure -taped devices, cutting a bottom of carrier tape with a cutter.

After replacing the cut portion shall be sealed with adhesive tape.

6.2.2 Adhesiveness of cover tape

• The exfoliation force between carrier tape and cover tape shall be 0.2N to 0.7N for the angle 160° to 180°.

6.2.3 Rolling method and quantity

Wind the tape back on the reel so that the cover tape will be outside the tape.
 Attach more than 20cm of blank tape to the trailer and the leader of the and fix the both ends with adhesive tape.
 One reel basically shall contain 2000pcs.

6.2.4 Outer packing appearance

· Refer to the attached sheet, page 9.

6.2.5 Marking

The label with following information shall be pasted at appointed place of the outer packing case.

- * Model No. *(Business dealing name) * Lot No. * Quantity
- * Country of origin *Company name *Inspection date specified

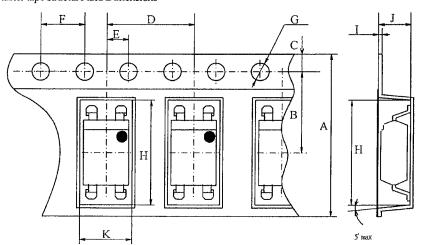
6.2.6 Storage condition

 Taped products shall be stored at the temperature 5 to 30°C and the humidity 70%RH or less away from direct sunlight.

6.2.7 Safety protection during shipping

· There shall be no deformation of component or degradation of electrical characteristics due to shipping.

Carrier tape structure and Dimensions

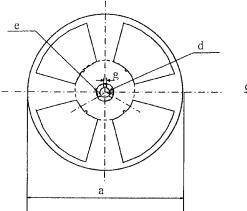


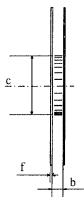
Dimensions list (Unit: mm)

	Α	В	С	D	Е	F	G	H	1	J	K	
	±0.3	±0.1	<u>±</u> 0.10	土0.1	±0.1	±0.1	+0.1 -0.0	±0.1	±0.05	±0.1	±0.1	
ı	16.0	7.5	1.75	8.0	2.0	4.0	ϕ 1.5	10.4	0.40	4.2	5.1	

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Reel structure and Dimensions

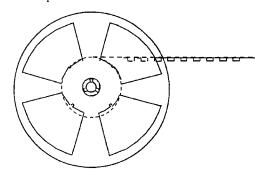


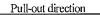


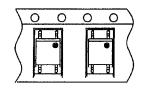
Dimensions list (Unit: mm)

a	ь	С	d
(330)	17.5±1.5	ϕ 100.0 \pm 1.0	φ13.0±0.5
С	f	g)	
φ23.0±1.0	2.0±0.5	2.0±0.5	

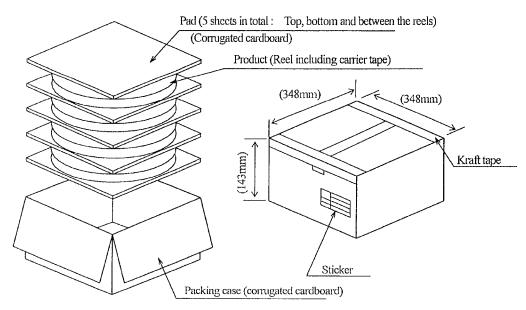
Direction of product insertion





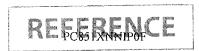


Outer packing appearance



Regular packing mass: Approx. 4.1kg

() : Reference dimensions



Precautions for Photocouplers

1 Cleaning

(1) Solvent cleaning: Solvent temperature 45°C or less

Immersion for 3 min or less

(2) Ultrasonic cleaning: The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output,

cleaning time, PCB size or device mounting condition etc. Please test it in actual using condition

and confirm that doesn't occur any defect before starting the ultrasonic cleaning.

(3) Applicable solvent: Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

When the other solvent is used, there are cases that the packaging resin is eroded.

Please use the other solvent after thorough confirmation is performed in actual using condition.

2. Circuit design

(1) The LED used in the Photocoupler generally decreases the light emission power by operation. In case of long operation time, please design the circuit in consideration of the degradation of the light emission power of the LED. (50%/5years)

(2) There are cases that the deviation of the CTR and the degradation of the relative light emission power of the LED increase when the setting value of I_r is less than 1.0mA. Please design the circuit in consideration of this point.

3. Precautions for Soldering

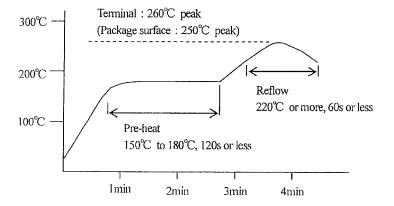
(1) In the case of flow soldering (Whole device dipping.)

It is recommended that flow soldering should be at 270°C or less for 10 s or less

(Pre-heating: 100 to 150°C, 30 to 80s). (2 times or less)

(2) If solder reflow:

It is recommended to be done at the temperature and the time within the temperature profile as shown in the figure below. (2 times or less)



(3) In the case of hand soldering

What is done on the following condition is recommended. (2 times or less)

Soldering iron temperature: 400°C or less

Time: 3s or less

(4) Other precautions

Depending on equipment and soldering conditions (temperature, Using solder etc.),

the effect to the device and the PCB is different.

Please confirm that there is no problem on the actual use conditions in advance.



1. This specification shall be applied to photocoupler, Model No. PC851 as an option.

2. Applicable Models (Business dealing name)

PC851XNYIP0F

3. The relevant models are the models Approved by VDE according to DIN EN 60747-5-2.

Approved Model No.: PC851

VDE approved No.: 40008087 (According to the specification DIN EN 60747-5-2)

 Operating isolation voltage UIORM

· Transient voltage : 9000V (Peak)

· Pollution : 2

· Clearances distance (Between input and output) : 6.4 mm (MIN.) Creepage distance (Between input and output) : 6.4 mm (MIN.) Isolation thickness between input and output : 0.15mm (MIN.)

· Tracking-proof : CTI 175

· Safety limit values Current (Isi) 200mA (Diode side)

> Power (Psi) 300mW (Phototransistor side)

: 890V (Peak)

: 150℃ Temperature (Tsi)

In order to keep safety electric isolation of photocoupler, please set the protective circuit to keep within safety limit values when the actual application equipment troubled.

· Indication of VDE approval



" is printed on minimum unit package.

4. Outline

Refer to the attachment-2-2.

5. Isolation specification according to EN 60747-5-2.

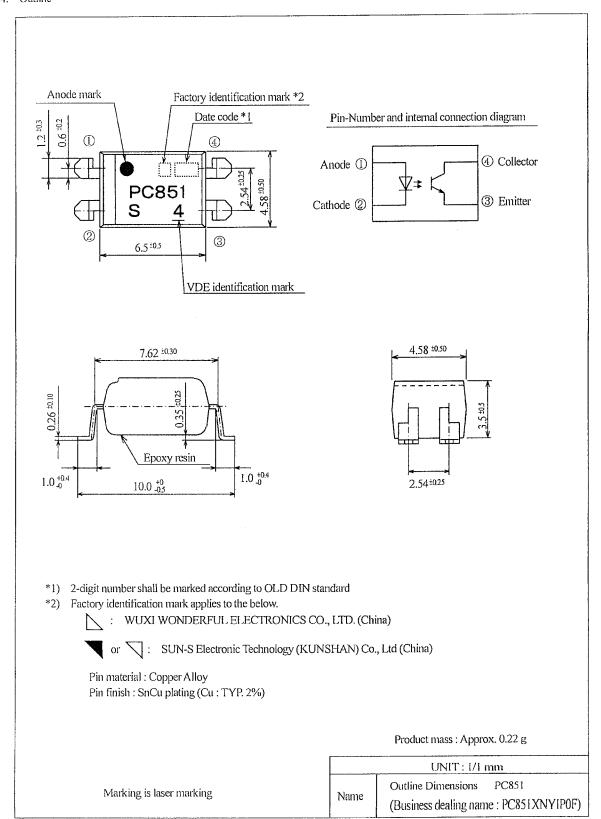
Parameter	Symbol	Condition	Rating	Unit	Remark
Class of environmental test	-	-	55/110/21	-	
Pollution	-	-	2	-	
Maximum operating isolation voltage	U _{IORM} (PEAK)	-	890	V	
Partial discharge test voltage (Between input and output)					Refer to
Diagram 1	Upr	tp=10s, qc<5pC	1340	V	the Diagram 1,2
Diagram 2	(PEAK)	tp=1s, qc<5pC	1670	٧	(Attachement-2-3)
Maximum over-voltage	U _{IOTM} (PEAK)	t _{iNi} =60 s	9000	٧	
Safety maximum ratings					D 0
1) Case temperature	Tsi	I _F =0, P _C =0,	150	Ç	Refer to Fig 6,7
2) Input current	Isi	P _C =0	200	ınA	(Attachement-2-3)
3) Electric power (Output or Total power dissipation)	Psi	-	300	mW	(Timerionian 2 3)
		Ta=Tsi	MIN.10 ⁹		
Isolation resistance (Test voltage between input and output; DC500V)	R _{ISO}	Ta=Topr(MAX.)	MIN.10 ¹¹	Ω	
(Test votinge between input and output, De500 v)		Ta=25°C	MIN.10 ¹²		

- 6. Precautions in performing isolation test
 - 6.1 Partial discharge test methods shall be the ones according to the specifications of EN 60747-5-2
 - 6.2 Please don't carry out isolation test (V_{iso}) over U_{IOIM}. This product deteriorates isolation characteristics by partial discharge due to applying high voltage (ex. U_{IOTM}).

And there is possibility that partial discharge occurs in operating isolation voltage. (U_{IORM}).

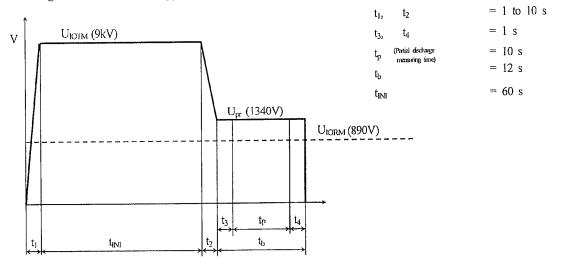
REFERENCE

4. Outline

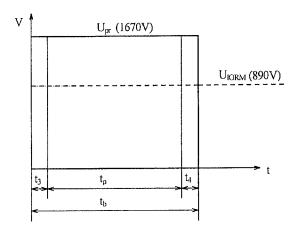


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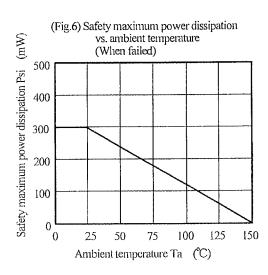
Method of Diagram 1: Breakdown test (Apply to type test and sampling test)

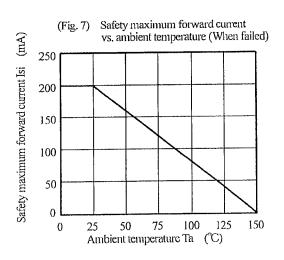


Method of Diagram 2: Non breakdown test (Apply to all device test)



t3,	t ₄	= 0.1 s
t _p	(Partial discharge measuring time)	= 1 s
tı,	(resouring units)	= 1.2 s





Opto Specification

Opto/EC Group



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